

MOS FIELD EFFECT TRANSISTOR μ PA1803

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1803 is a switching device which can be driven directly by a 4.5-V power source.

The μ PA1803 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- Can be driven by a 4.5-V power source
- · Low on-state resistance

 $R_{\text{DS(on)1}}$ = 12 $m\Omega$ MAX. (Vgs = 10 V, Ip = 4.0 A)

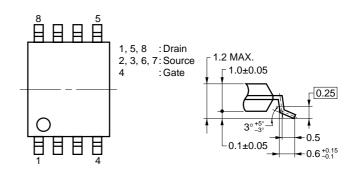
 $R_{DS(on)2} = 16 \text{ m}\Omega \text{ MAX.} \text{ (VGS} = 4.5 \text{ V, ID} = 4.0 \text{ A)}$

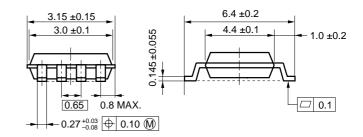
• Built-in G-S protection diode against ESD

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1803GR-9JG	Power TSSOP8

PACKAGE DRAWING (Unit: mm)

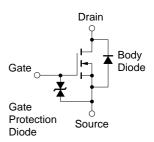




ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	Voss	30	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±8.0	Α
Drain Current (pulse) Note1	D(pulse)	±32	Α
Total Power Dissipation Note2	Рт	2.0	W
Channel Temperature	T_ch	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

EQUIVALENT CIRCUIT



Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Mounted on ceramic substrate of 5000 mm² x 1.1 mm

Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



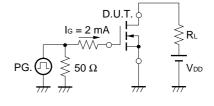
ELECTRICAL CHARACTERISTICS (TA = 25°C)

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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Inss	Vps = 30 V, Vgs = 0 V			10	μΑ
Gate Leakage Current	lgss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0	1.9	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 4.0 A	3	14		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 4.0 A		8.6	12	mΩ
	R _{DS(on)2}	VGS = 4.5 V, ID = 4.0 A		11	16	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1880		pF
Output Capacitance	Coss	V _G S = 0 V		571		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		214		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15 V		27		ns
Rise Time	tr	ID = 4.0 A		77		ns
Turn-off Delay Time	t _{d(off)}	V _{GS(on)} = 10 V		72		ns
Fall Time	tf	$R_G = 10 \Omega$		47		ns
Total Gate Charge	QG	V _{DS} = 24 V		36		nC
Gate to Source Charge	Qgs	ID = 8.0 A		5.1		nC
Gate to Drain Charge	Q _{GD}	Vgs = 10 V		8.7		nC
Diode Forward Voltage	VF(S-D)	IF = 8.0 A, VGS = 0 V		0.78		V
Reverse Recovery Time	trr	IF = 8.0 A, VGS = 0 V		37		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		35		nC

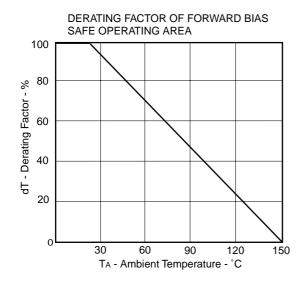
TEST CIRCUIT 1 SWITCHING TIME

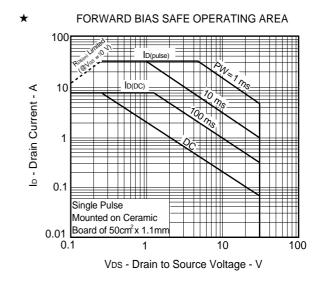
PG. $\bigcap_{RG} R_G = 10 \ \Omega$ $V_{GS} \bigvee_{Wave Form} V_{GS} \bigvee_{V_{GS}(on)} 90 \%$ $V_{GS} \bigvee_{Wave Form} 0 10 \% \bigvee_{U_{D}} V_{GS(on)} \bigvee_{U_{D}} 90 \%$ $V_{GS} \bigvee_{U_{D}} V_{GS(on)} \bigvee_{U_$

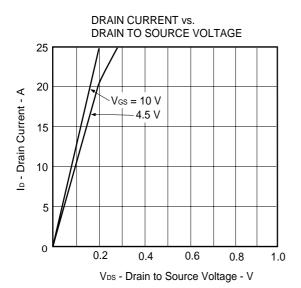
TEST CIRCUIT 2 GATE CHARGE

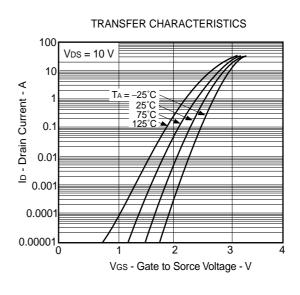


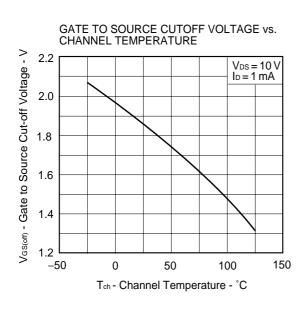
TYPICAL CHARACTERISTICS (TA = 25°C)

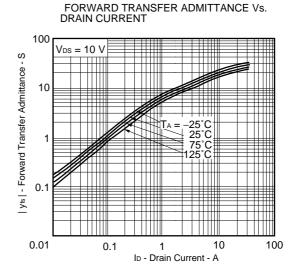




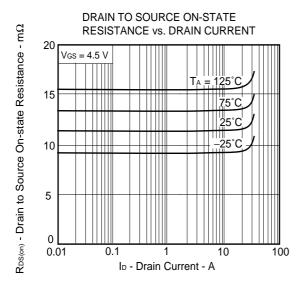


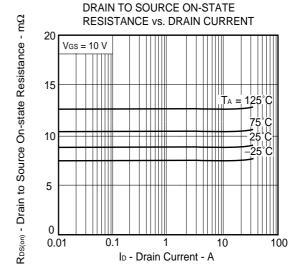


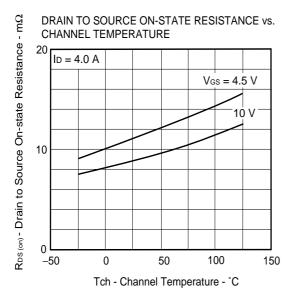


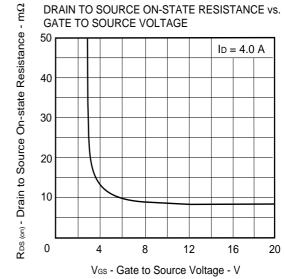


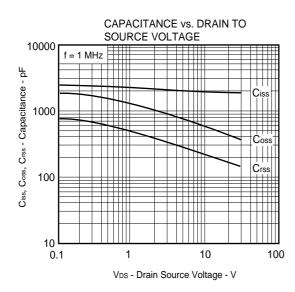
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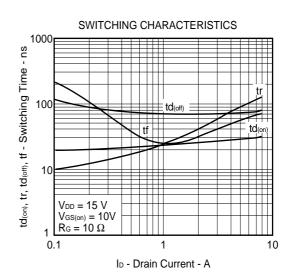




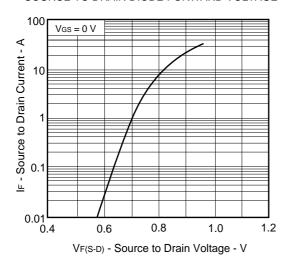


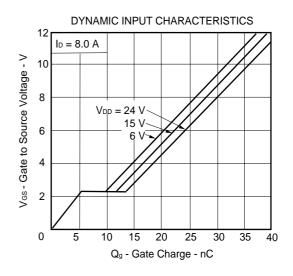




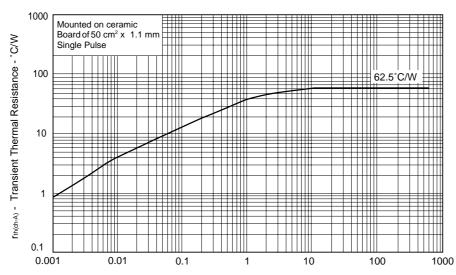


SOURCE TO DRAIN DIODE FORWARD VOLTAGE





★ TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s

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NEC μ PA1803

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